SKT 10

Stud Thyristor

Line Thyristor

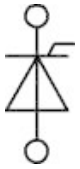
SKT 10

Features

- Hermetic metal case with glass insulator
- Threaded stud ISO M5
- International standard case

Typical Applications*

- DC motor control (e. g. for machine tools)
- Controlled rectifiers (e. g. for battery charging)
- AC controllers (e. g. for temperature control)
- Recommended snubber network e.g. for $V_{VRMS} \leq 400$ V: R = 100 Ω/5 W, C = 0,1 µF



SKT

V_{RSM} V	V_{RRM}, V_{DRM} V	I_{TRMS} = 30 A (maximum value for continuous operation) I_{TAV} = 10 A (sin. 180; T_c = 111 °C)		
700	600	SKT 10/06D		
900	800	SKT 10/08D		
1300	1200	SKT 10/12E		

Symbol	Conditions	Values	Units
I_{TAV}	sin. 180; T_c = 100 (85) °C;	14 (19)	A
I_D	K9; T_a = 45 °C; B2 / B6	12 / 16,5	A
	K5; T_a = 45 °C; B2 / B6	17 /24	A
I_{RMS}	K9; T_a = 45 °C; W1C	13	A
I_{TSM}	T_{vj} = 25 °C; 10 ms	250	A
	T_{vj} = 130 °C; 10 ms	210	A
i²t	T_{vj} = 25 °C; 8,35 ... 10 ms	310	A²s
	T_{vj} = 130 °C; 8,35 ... 10 ms	220	A²s
V_T	T_{vj} = 25 °C; I_T = 30 A	max. 1,6	V
$V_{T(TO)}$	T_{vj} = 130 °C	max. 1	V
r_T	T_{vj} = 130 °C	max. 18	mΩ
I_{DD}; I_{RD}	T_{vj} = 130 °C; V_{RD} = V_{RRM}; V_{DD} = V_{DRM}	max. 4	mA
t_{gd}	T_{vj} = 25 °C; I_G = 1 A; di_G/dt = 1 A/µs	1	µs
t_{gr}	V_D = 0,67 * V_{DRM}	2	µs
$(di/dt)_{cr}$	T_{vj} = 125 °C	max. 50	A/µs
$(dv/dt)_{cr}$	T_{vj} = 125 °C ; SKT ...D / SKT ...E	max. 500 / 1000	V/µs
t_q	T_{vj} = 130 °C ,	80	µs
I_H	T_{vj} = 25 °C; typ. / max.	80 / 150	mA
I_L	T_{vj} = 25 °C; typ. / max.	150 / 300	mA
V_{GT}	T_{vj} = 25 °C; d.c.	min. 3	V
I_{GT}	T_{vj} = 25 °C; d.c.	min. 100	mA
V_{GD}	T_{vj} = 130 °C; d.c.	max. 0,25	V
I_{GD}	T_{vj} = 130 °C; d.c.	max. 3	mA
$R_{th(j-c)}$	cont.	1,2	K/W
$R_{th(j-c)}$	sin. 180	1,3	K/W
$R_{th(j-c)}$	rec. 120	1,35	K/W
$R_{th(c-s)}$		1	K/W
T_{vj}		- 40 ... + 130	°C
T_{stg}		- 40 ... + 150	°C
V_{isol}		-	V~
M_s	to heatsink	2,0	Nm
a		5 * 9,81	m/s²
m	approx.	7	g
Case		B 1	

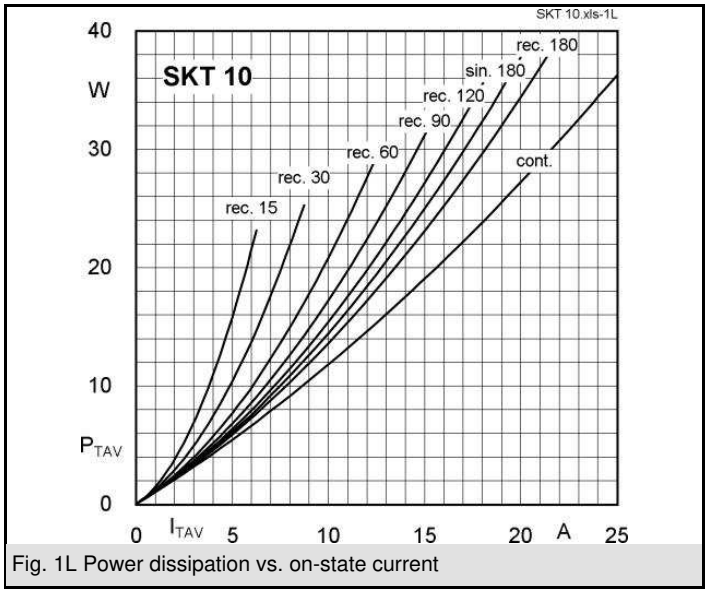


Fig. 1L Power dissipation vs. on-state current

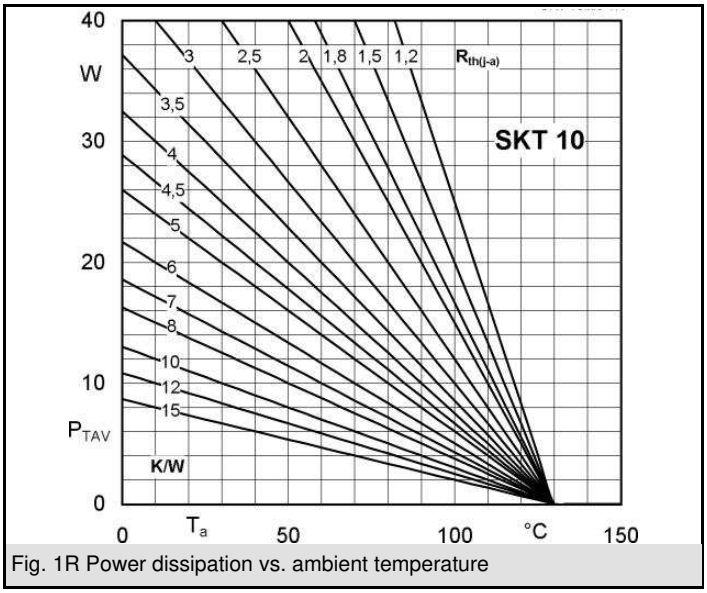


Fig. 1R Power dissipation vs. ambient temperature

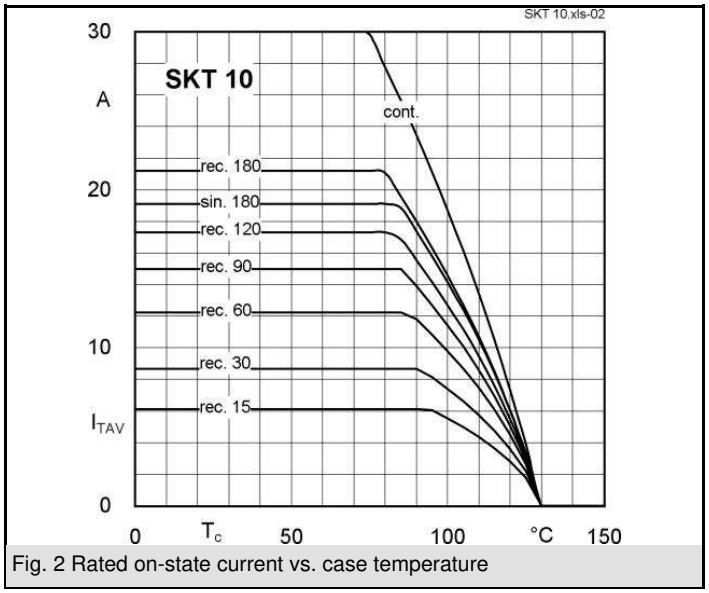


Fig. 2 Rated on-state current vs. case temperature

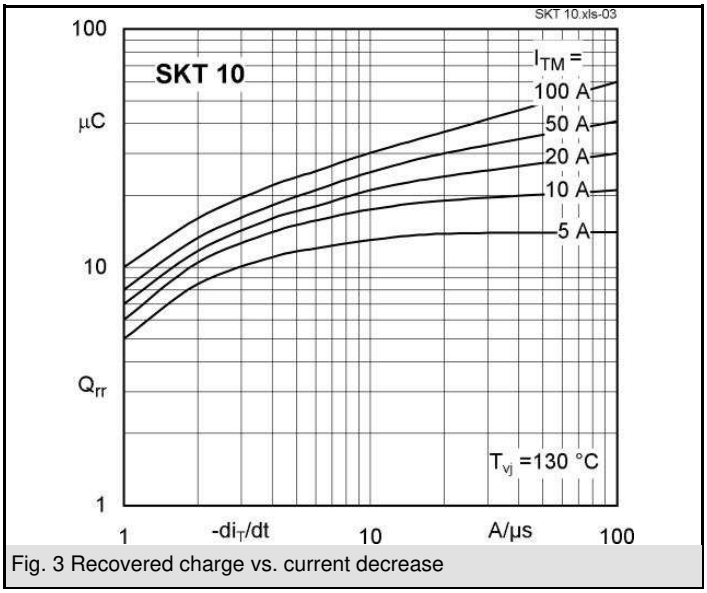


Fig. 3 Recovered charge vs. current decrease

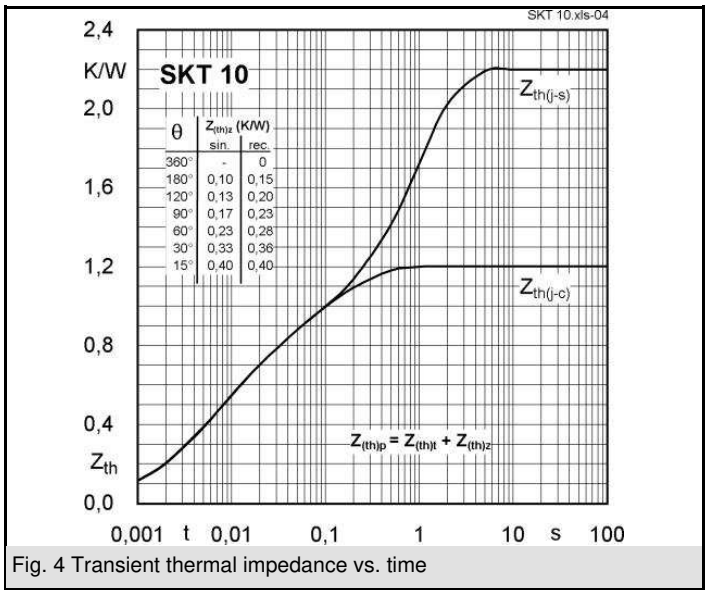


Fig. 4 Transient thermal impedance vs. time

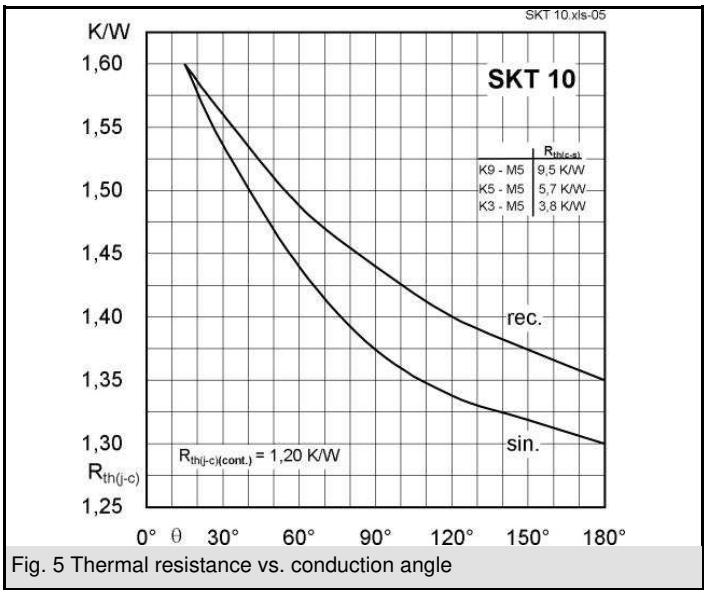


Fig. 5 Thermal resistance vs. conduction angle

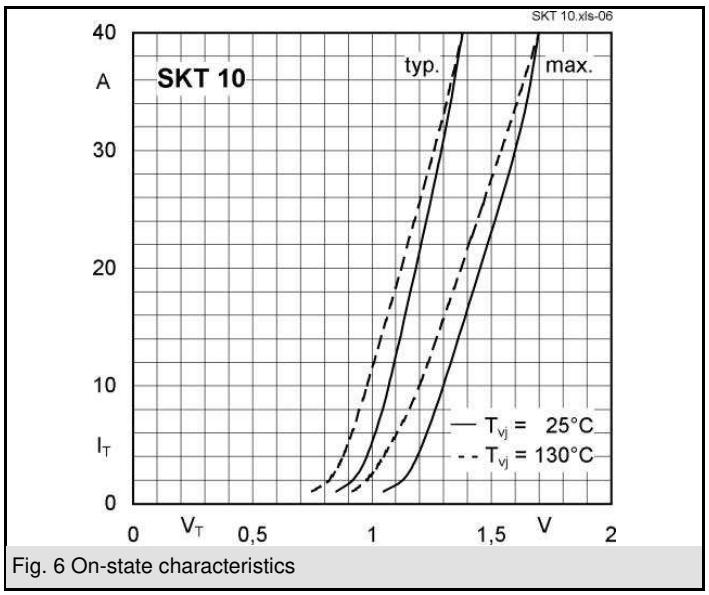


Fig. 6 On-state characteristics

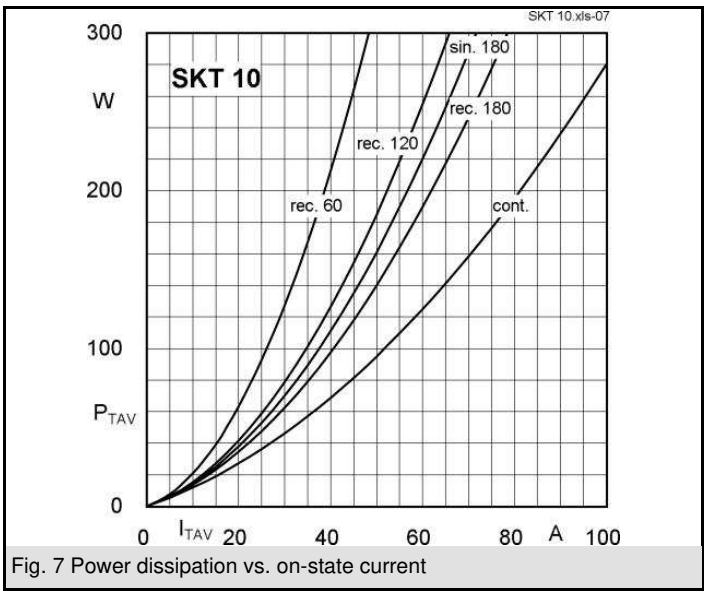


Fig. 7 Power dissipation vs. on-state current

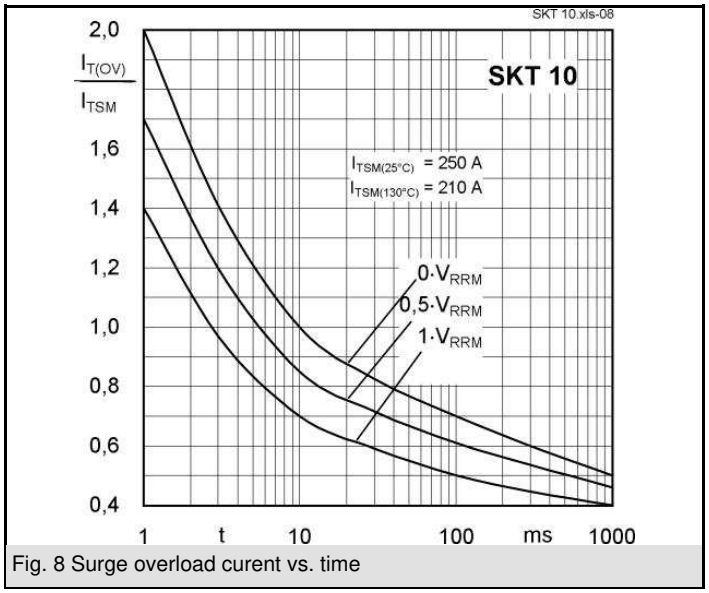


Fig. 8 Surge overload curent vs. time

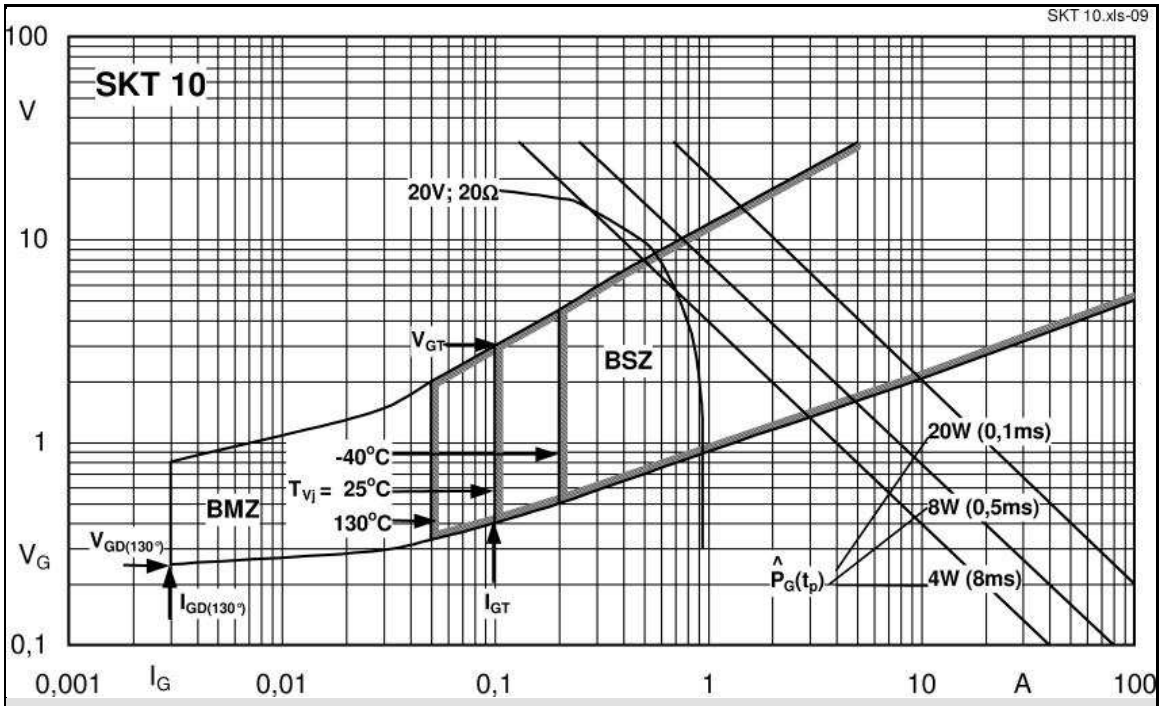
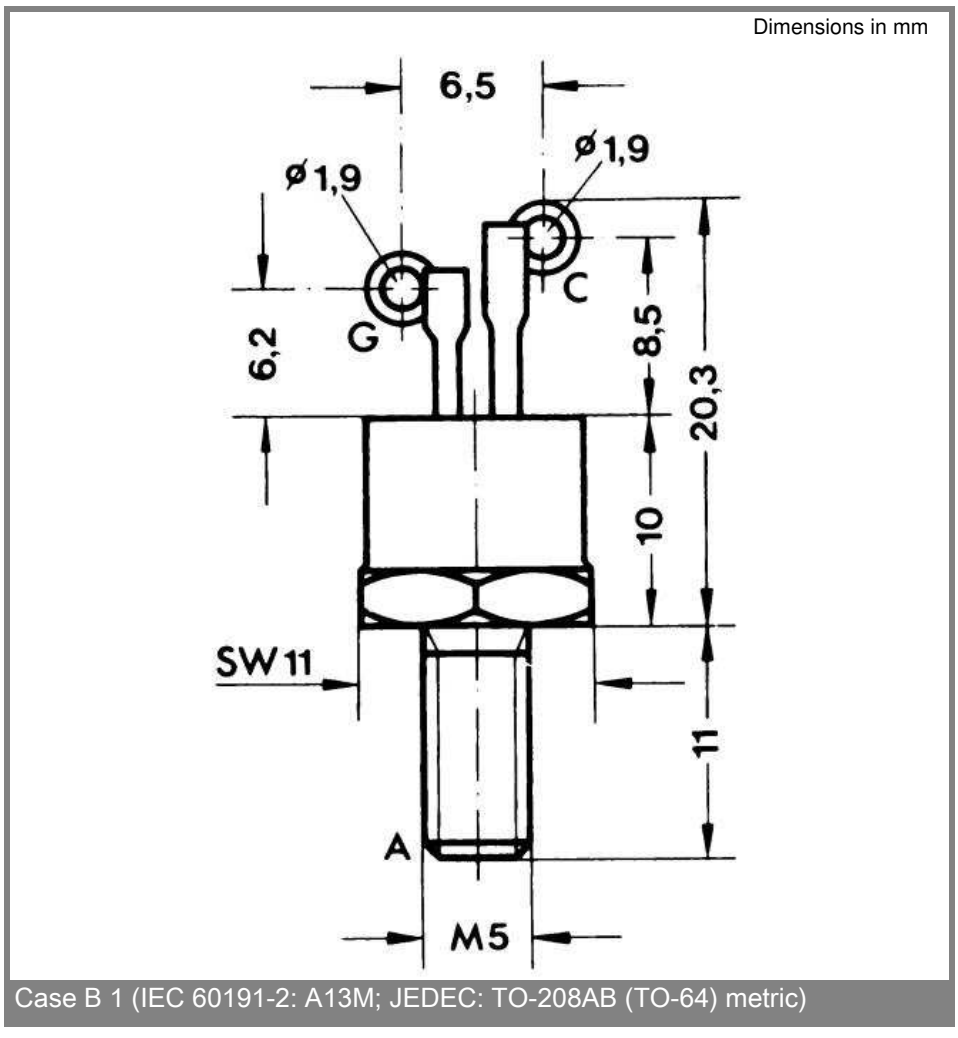


Fig. 9 Gate trigger characteristics



Case B 1 (IEC 60191-2: A13M; JEDEC: TO-208AB (TO-64) metric)

* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON

products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our personal.

